IPC ASSOCIATION CONNE ELECTRONICS INDUS	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1	Porm Type http://www.ipc.org/IPC-175x Standard Form Type Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials an					1fg Inf	formation			
Supplier Info	ormation														
Company name* Company unique ID					Unique ID Authority				Respon	Response Date*					
nsemi											2025-00	2025-06-08			
Contact Name Title - C				itle - Contact			Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards Product Enviro Compl				ro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative					Phone - Representative*				Email -	Email - Representative*					
Product-Env-Stewards Product Enviro			o Compliance			NA				Produc	Product-Env-Stewards@onsemi.com				
Requ	equester Item Number Mfr Item Numb			Tumber Mfr Item Name			Effective Date	Version	sion Manufacturing Site		te	Weight* UOM		UOM	Unit Type
		MT9V034C12STM- DP1 VGA 1/3 GS CIS			S		2025-06-08	25-06-08 TWU				776.08 mg Each			
lanufacturii	ng Proccess Information							,							·
Termi	Terminal Plating / Grid Array Material		Terminal Base Alloy J-S		J-STD-020 M	SL Rating Peak		Process Body Temperature		re Max Time at Peak Tempera		ture	e Number of Reflow Cycles		eles
Precio Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			4		260		С	30	secon	seconds 3				
omments					·					<u> </u>					

RoHS Material Composition Declaration			Declaration Type *	Detail	ed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).												
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.												
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Ceramic Substrate	542.28	mg	Supplier	Cobalt (Co)	7440-48-4		0.705	mg
			Supplier	Titanium Dioxide (TiO2)	13463-67-7		5.4228	mg
			Supplier	Molybdenum (Mo)	7439-98-7		5.4228	mg
			Supplier	Tungsten (W)	7440-33-7		22.83	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		3.2537	mg
			Supplier	Calcium Oxide (CaO)	60873-85-0		2.7656	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		15.1838	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		462.2937	mg
			В	Nickel (Ni)	7440-02-0		2.2233	mg
			Supplier	Gold (Au)	7440-57-5		1.3557	mg
			Supplier	Chromium Trioxide (Cr2O3)	1308-38-9		20.8236	mg
Die	49.22	mg		Misc.	proprietary data		0.187	mg
			Supplier	Silicon (Si)	7440-21-3		48.5457	mg
			Supplier	Aluminum (Al)	7429-90-5		0.4873	mg
Die Attach	25.14	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		1.0835	mg
			Supplier	Epoxy resins	129915-35-1		7.7607	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		9.1535	mg
			Supplier	Acrylic resins	Proprietary Data		7.1423	mg
Imaging Lens	151.66	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		7.9622	mg
			Supplier	Sodium Monoxide (Na2O)	1313-59-3		7.7347	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		7.9622	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		7.7802	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.7583	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		7.6588	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		7.674	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		104.1298	mg
Lid Attach	5.79	mg		Other Additive Agents	proprietary data		1.0086	mg
			Supplier	Photoinitiator	Proprietary Data		0.2362	mg
			Supplier	Epoxy Prepolymer	Proprietary Data		4.5452	mg
Marking Ink	0.05	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.042	mg
			Supplier	1-Methoxy-2-propyl acetate (MPA)	108-65-6		0.0024	mg
			Supplier	Butylglycol Acetate	112-07-2		0.0024	mg

			Supplier	Cyclohexanone	108-94-1	0.0025	mg
			Supplier	Xylene	1330-20-7	0.0007	mg
Wire Bond - Au	1.94	mg	Supplier	Gold (Au)	7440-57-5	1.94	mg